



Vincotech

V23990-P769-A-PM**V23990-P769-AY-PM**

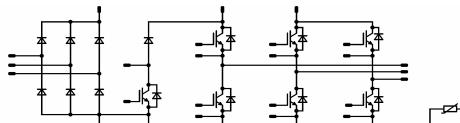
datasheet

flow PIM 2**1200 V / 75 A****Features**

- Three-phase rectifier, BRC, Inverter, NTC
- Very Compact housing, easy to route
- IGBT4/ EmCon4 technology for low saturation losses and improved EMC behavior

flow 2 17mm housing**Target Applications**

- Motor Drives
- Power Generation

Schematic**Types**

- V23990-P769-A
- V23990-P769-AY

Maximum Ratings $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
------------------	---------------	------------------	--------------	-------------

Input Rectifier Diode

Repetitive peak reverse voltage	V_{RRM}		1600	V
Forward current	I_{FAV}		75	A
Surge (non-repetitive) forward current	I_{FSM}		1000	A
I ² t-value	I^2t	$t_p = 10 \text{ ms}$	5000	A ² s
Power dissipation	P_{tot}	$T_j = T_{jmax}$	156	W
Maximum Junction Temperature	T_{jmax}		150	°C

Inverter Switch

Collector-emitter breakdown voltage	V_{CE}		1200	V
DC collector current	I_C		70	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	210	A
Power dissipation	P_{tot}	$T_j = T_{jmax}$	239	W
Gate-emitter peak voltage	V_{GE}		±20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j \leq 150^\circ\text{C}$ $V_{GE} = 15 \text{ V}$	10 800	μs V
Maximum Junction Temperature	T_{jmax}		175	°C



Vincotech

V23990-P769-A-PM

V23990-P769-AY-PM

datasheet

Maximum Ratings

 $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
-----------	--------	-----------	-------	------

Inverter Diode

Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
DC forward current	I_F		75	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	150	A
Power dissipation	P_{tot}	$T_j = T_{jmax}$	154	W
Maximum Junction Temperature	T_{jmax}		175	°C

Brake Switch

Collector-emitter breakdown voltage	V_{CE}		1200	V
DC collector current	I_C		50	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Power dissipation	P_{tot}	$T_j = T_{jmax}$	174	W
Gate-emitter peak voltage	V_{GE}		±20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j \leq 150^\circ\text{C}$ $V_{GE} = 15\text{ V}$	10 800	μs V
Maximum Junction Temperature	T_{jmax}		175	°C

Brake Inverse Diode

Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
DC forward current	I_F		10	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	20	A
Brake Inverse Diode	P_{tot}	$T_j = T_{jmax}$	56	W
Maximum Junction Temperature	T_{jmax}		175	°C

Brake Diode

Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
DC forward current	I_F		25	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	50	A
Power dissipation	P_{tot}	$T_j = T_{jmax}$	87	W
Maximum Junction Temperature	T_{jmax}		175	°C

Thermal properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{op}		-40...+ T_{jmax} -25	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage*	$t_p = 2\text{ s}$	4000	V
		AC Voltage	$t_p = 1\text{ min}$	2500	V
Creepage distance				min 12,7	mm
Clearance		with Press-fit pins / with Solder pins		11,58 / 11,82	mm
Comparative Tracking Index	CTI			>200	

* 100 % tested in production



Vincotech

V23990-P769-A-PM

V23990-P769-AY-PM

datasheet

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
		V_{GE} [V]	V_r [V]	I_c [A]	T_j [°C]	Min	Typ	Max			
	V_{GS} [V]	V_{CE} [V]	I_F [A]	I_D [A]							

Input Rectifier Diode

Forward voltage	V_F			100	25 125		1,18 1,16	1,9	V
Threshold voltage (for power loss calc. only)	V_{to}				25 125		0,87 0,79		V
Slope resistance (for power loss calc. only)	r_t				25 125		0,003 0,004		Ω
Reverse current	I_r		1500		25 125			0,05 1,1	mA
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)					0,45		K/W

Inverter Switch

Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$		0,0024	25	5	5,8	6,5	V
Collector-emitter saturation voltage	V_{CESat}		15	75	25 150		1,96 2,47	2,1	V
Collector-emitter cut-off current incl. Diode	I_{CES}		0	1200		25		0,025	mA
Gate-emitter leakage current	I_{GES}		20	0	25			200	nA
Integrated Gate resistor	R_{gint}						none		Ω
Turn-on delay time	$t_{d(on)}$	$R_{goff} = 8 \Omega$ $R_{gon} = 8 \Omega$	± 15	600	75	25 150	106 86		
Rise time	t_r					25 150	24 23		ns
Turn-off delay time	$t_{d(off)}$					25 150	188 270		
Fall time	t_f					25 150	64,9 114		
Turn-on energy loss	E_{on}					25 150	3,97 6,39		mWs
Turn-off energy loss	E_{off}					25 150	3,63 6,39		
Input capacitance	C_{ies}						3900		
Output capacitance	C_{oss}						310		pF
Reverse transfer capacitance	C_{rss}						230		
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)					0,40		K/W

Inverter Diode

Diode forward voltage	V_F			75	25 150		1,81 1,83	2,4	V
Peak reverse recovery current	I_{RRM}	$R_{gon} = 8 \Omega$	± 15	600	75	25 150	46,6 117		A
Reverse recovery time	t_{rr}					25 150	287 310		ns
Reverse recovered charge	Q_{rr}					25 150	4,17 14,13		μC
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 150	2312 1378		A/μs
Reverse recovered energy	E_{rec}					25 150	1,78 5,64		mWs
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)					0,62		K/W



Vincotech

V23990-P769-A-PM

V23990-P769-AY-PM

datasheet

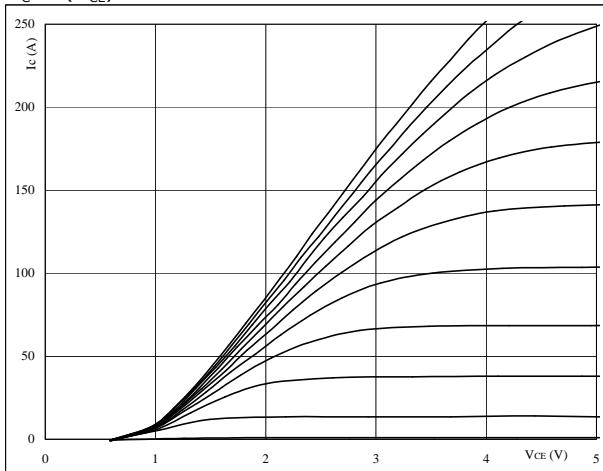
Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
		V_{GE} [V]	V_r [V]	I_c [A]	I_F [A]	T_j [$^{\circ}$ C]	I_D [A]	Min	Typ	Max	
Brake Switch											
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0017	25		5	5,8	6,5	V
Collector-emitter saturation voltage	V_{CESat}		15		50	25 150			1,9 2,3	2,3	V
Collector-emitter cut-off incl diode	I_{CES}		0	1200		25				0,25	mA
Gate-emitter leakage current	I_{GES}		20	0		25				200	nA
Integrated Gate resistor	R_{gint}							4			Ω
Turn-on delay time	$t_{d(on)}$	$R_{goff} = 8 \Omega$ $R_{gon} = 8 \Omega$	± 15	600	50	25 150		98 103			ns
Rise time	t_r					25 150		18 25			
Turn-off delay time	$t_{d(off)}$					25 150		208 284			
Fall time	t_f					25 150		66 112			
Turn-on energy loss	E_{on}					25 150		2,43 3,46			mWs
Turn-off energy loss	E_{off}					25 150		2,45 4,23			
Input capacitance	C_{ies}							2770			
Output capacitance	C_{oss}						25	205			pF
Reverse transfer capacitance	C_{rss}							160			
Gate charge	Q_G		± 15	960		25		290			nC
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,54			K/W
Brake Inverse Diode											
Diode forward voltage	V_F				10	25 150		1,1 1,81	1,81 1,81	2,1	V
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)							1,68		K/W
Brake Diode											
Diode forward voltage	V_F				25	25 150			1,82 1,82	2,2	V
Reverse leakage current	I_r	$R_{gon} = 8 \Omega$	± 15	600	50	25				10	μ A
Peak reverse recovery current	I_{RRM}					25 150			51 52		A
Reverse recovery time	t_{rr}					25 150			152 328		ns
Reverse recovered charge	Q_{rr}					25 150			3,07 6,3		μ C
Peak rate of fall of recovery current	$(di_{rd}/dt)_{max}$					25 150			3443 806		A/ μ s
Reverse recovery energy	E_{rec}					25 150			3,07 6,3		mWs
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)							1,09		K/W
Thermistor											
Rated resistance	R_{25}					25		22			$k\Omega$
Deviation of R_{100}	$D_{R/R}$	$R_{100}=1486\Omega$				100	-12		12		%
Power dissipation	P					25		200			mW
Power dissipation constant						25		2			mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 3\%$				25		3950			K
B-value	$B_{(25/100)}$	Tol. $\pm 3\%$				25		3998			K
Vincotech NTC Reference									B		

Output Inverter

figure 1.
Typical output characteristics

$$I_C = f(V_{CE})$$


IGBT
At

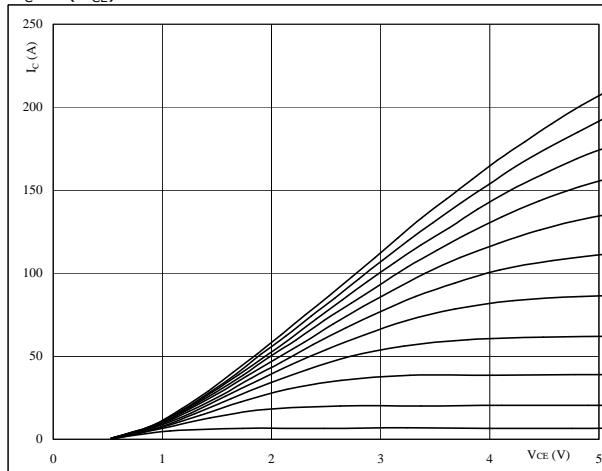
$$t_p = 250 \mu\text{s}$$

$$T_j = 25^\circ\text{C}$$

VGE from 7 V to 17 V in steps of 1 V

figure 2.
Typical output characteristics

$$I_C = f(V_{CE})$$


IGBT
At

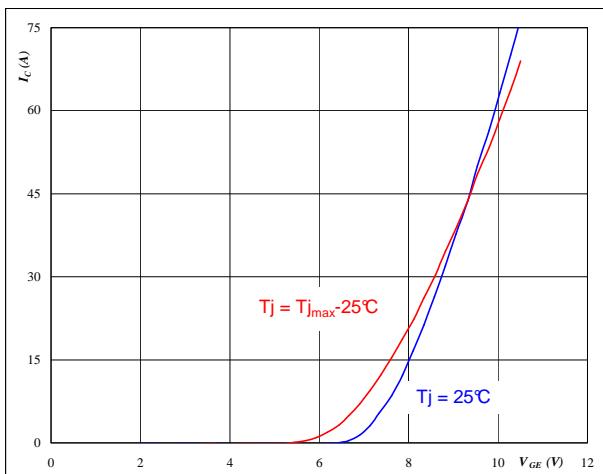
$$t_p = 250 \mu\text{s}$$

$$T_j = 150^\circ\text{C}$$

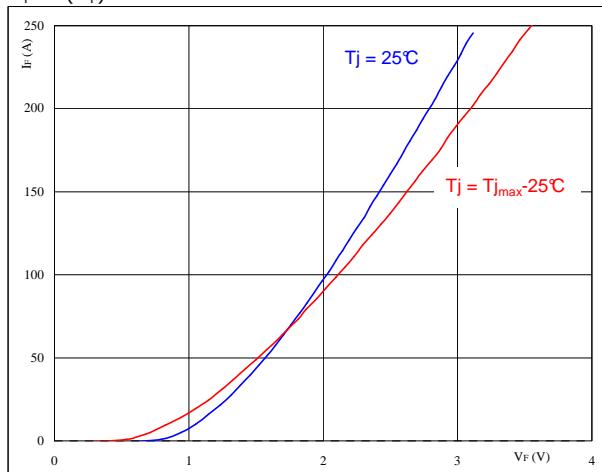
VGE from 7 V to 17 V in steps of 1 V

figure 3.
IGBT
Typical transfer characteristics

$$I_c = f(V_{GE})$$


figure 4.
FWD
Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$


At

$$t_p = 250 \mu\text{s}$$

$$V_{CE} = 10 \text{ V}$$

At

$$t_p = 250 \mu\text{s}$$

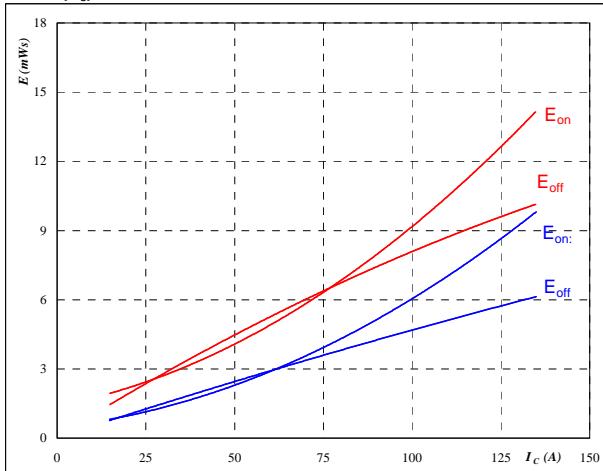
Output Inverter

figure 5.

IGBT

**Typical switching energy losses
as a function of collector current**

$$E = f(I_c)$$



With an inductive load at

$$T_j = \textcolor{blue}{25/150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 8 \quad \Omega$$

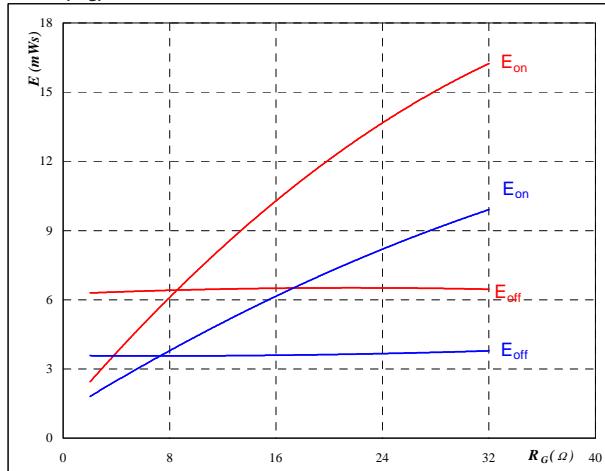
$$R_{goff} = 8 \quad \Omega$$

figure 6.

IGBT

**Typical switching energy losses
as a function of gate resistor**

$$E = f(R_G)$$



With an inductive load at

$$T_j = \textcolor{blue}{25/150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

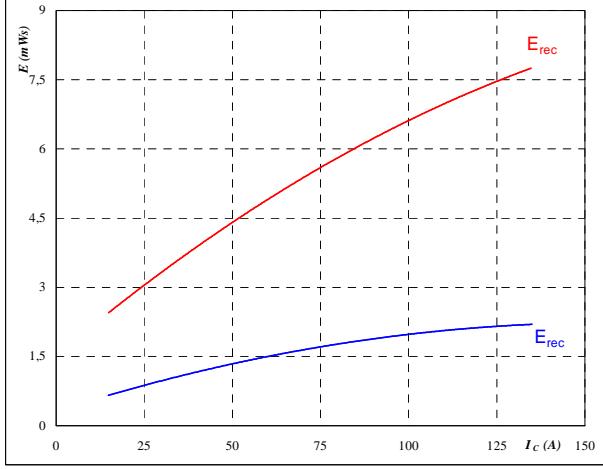
$$I_C = 75 \quad \text{A}$$

figure 7.

IGBT

**Typical reverse recovery energy loss
as a function of collector current**

$$E_{rec} = f(I_c)$$



With an inductive load at

$$T_j = \textcolor{blue}{25/150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

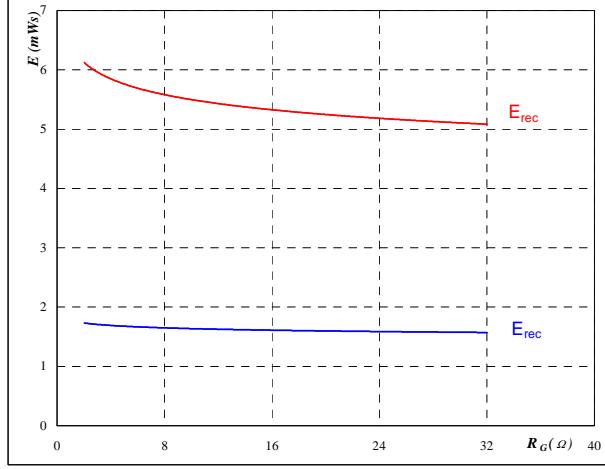
$$R_{gon} = 8 \quad \Omega$$

figure 8.

IGBT

**Typical reverse recovery energy loss
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

$$T_j = \textcolor{blue}{25/150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

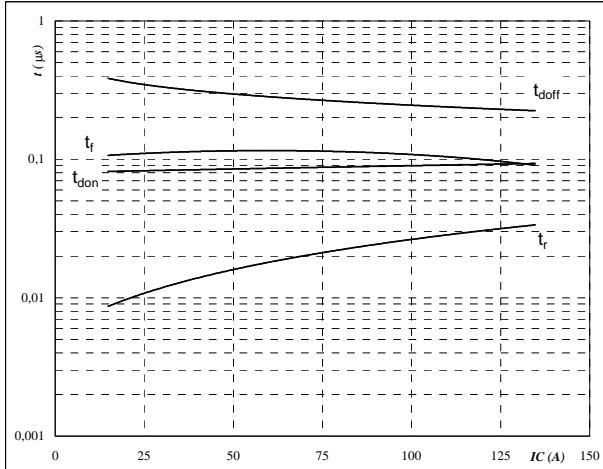
$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_C = 75 \quad \text{A}$$

Output Inverter

figure 9.
Typical switching times as a function of collector current

$$t = f(I_C)$$



With an inductive load at

$$T_j = 150 \text{ } ^\circ\text{C}$$

$$V_{CE} = 600 \text{ V}$$

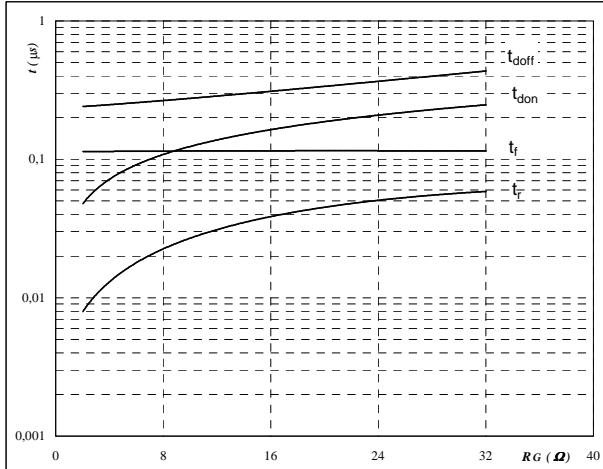
$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 8 \text{ } \Omega$$

$$R_{goff} = 8 \text{ } \Omega$$

IGBT
figure 10.
Typical switching times as a function of gate resistor

$$t = f(R_G)$$



With an inductive load at

$$T_j = 150 \text{ } ^\circ\text{C}$$

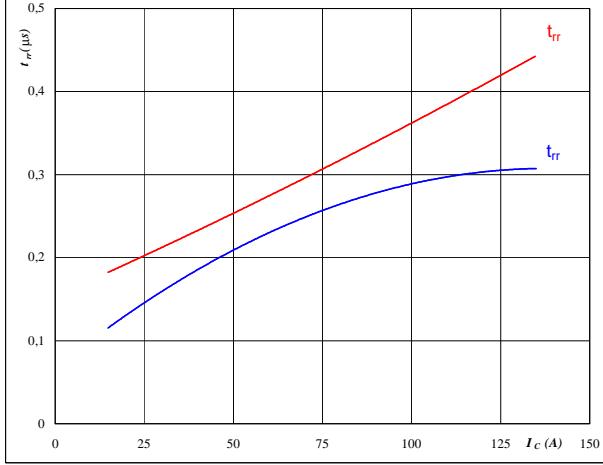
$$V_{CE} = 600 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$I_C = 75 \text{ A}$$

figure 11.
FWD
Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$


At

$$T_j = 25/150 \text{ } ^\circ\text{C}$$

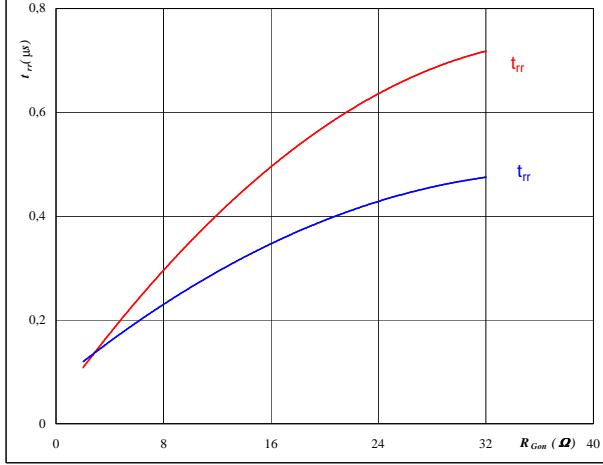
$$V_{CE} = 600 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 8 \text{ } \Omega$$

figure 12.
FWD
Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$


At

$$T_j = 25/150 \text{ } ^\circ\text{C}$$

$$V_R = 600 \text{ V}$$

$$I_F = 75 \text{ A}$$

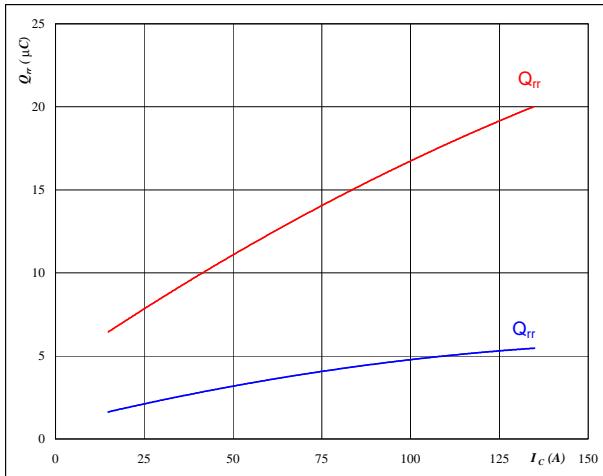
$$V_{GE} = \pm 15 \text{ V}$$

Output Inverter

figure 13.**FWD**

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_c)$$

**At**

$$T_j = \textcolor{blue}{25/150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

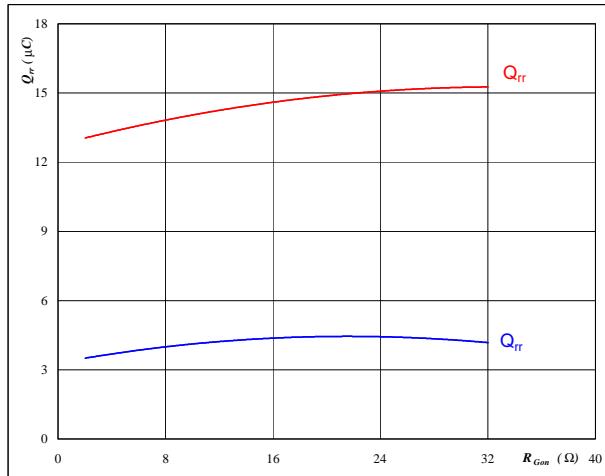
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 8 \quad \Omega$$

figure 14.**FWD**

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

**At**

$$T_j = \textcolor{blue}{25/150} \quad ^\circ\text{C}$$

$$V_R = 600 \quad \text{V}$$

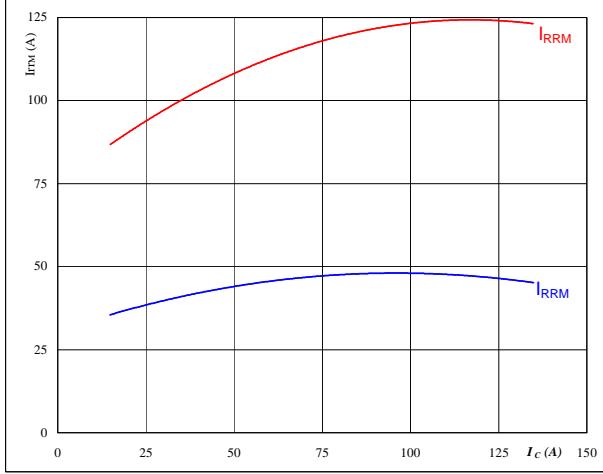
$$I_F = 75 \quad \text{A}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

figure 15.**FWD**

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_c)$$

**At**

$$T_j = \textcolor{blue}{25/150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

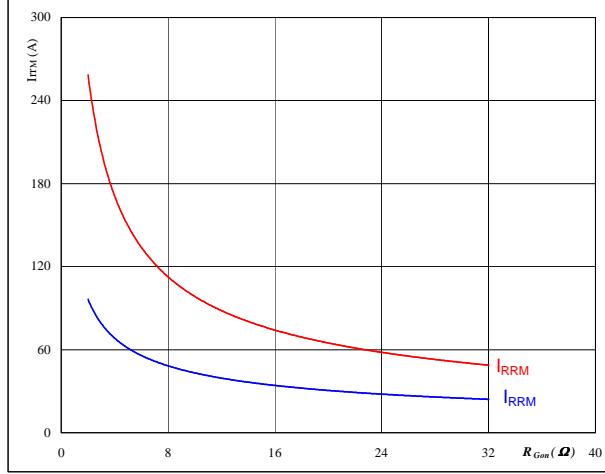
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 8 \quad \Omega$$

figure 16.**FWD**

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$

**At**

$$T_j = \textcolor{blue}{25/150} \quad ^\circ\text{C}$$

$$V_R = 600 \quad \text{V}$$

$$I_F = 75 \quad \text{A}$$

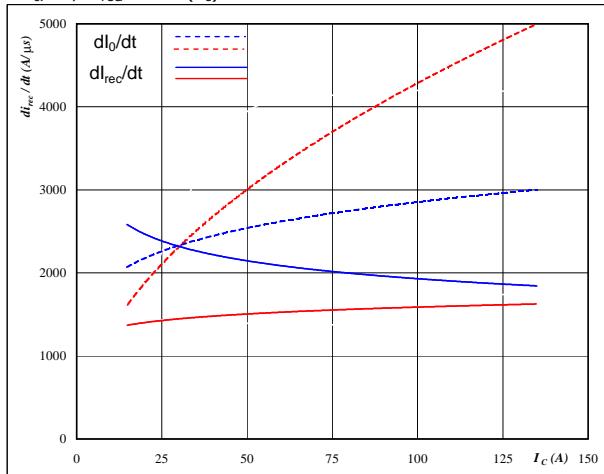
$$V_{GE} = \pm 15 \quad \text{V}$$

Output Inverter

figure 17.

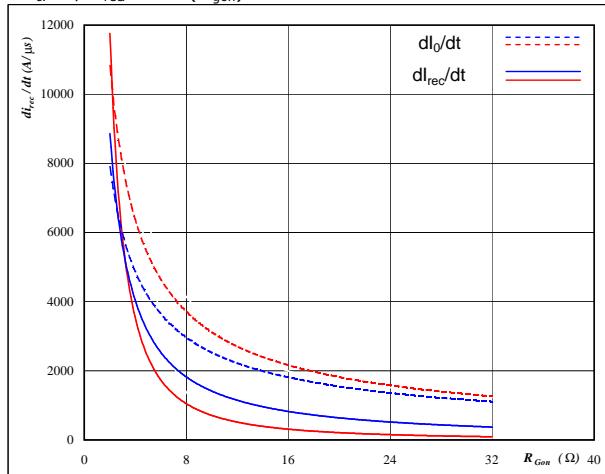
FWD

**Typical rate of fall of forward
and reverse recovery current as a
function of collector current**
 $dI_0/dt, dI_{rec}/dt = f(I_c)$

**At** $T_j = 25/150 \text{ } ^\circ\text{C}$ $V_{CE} = 600 \text{ V}$ $V_{GE} = \pm 15 \text{ V}$ $R_{gon} = 8 \Omega$ **figure 18.**

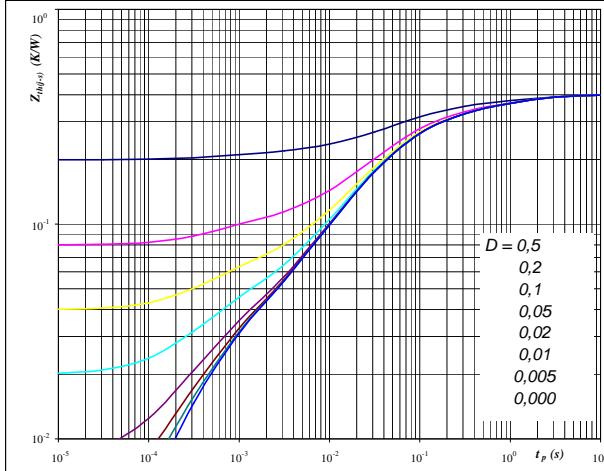
FWD

**Typical rate of fall of forward
and reverse recovery current as a
function of IGBT turn on gate resistor**
 $dI_0/dt, dI_{rec}/dt = f(R_{gon})$

**At** $T_j = 25/150 \text{ } ^\circ\text{C}$ $V_R = 600 \text{ V}$ $I_F = 75 \text{ A}$ $V_{GE} = \pm 15 \text{ V}$ **figure 19.**

IGBT

**IGBT transient thermal impedance
as a function of pulse width**

 $Z_{th(j-s)} = f(t_p)$ **At** $D = t_p / T$ $R_{th(j-s)} = 0,40 \text{ K/W}$

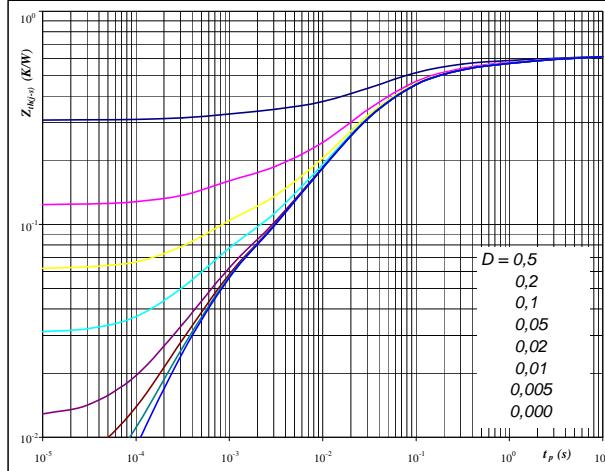
IGBT thermal model values

R (K/W)	Tau (s)
6,24E-02	1,56E+00
9,03E-02	2,15E-01
1,40E-01	5,06E-02
6,78E-02	1,56E-02
1,66E-02	3,11E-03
2,14E-02	4,58E-04

figure 20.

FWD

**FWD transient thermal impedance
as a function of pulse width**

 $Z_{th(j-s)} = f(t_p)$ **At** $D = t_p / T$ $R_{th(j-s)} = 0,62 \text{ K/W}$

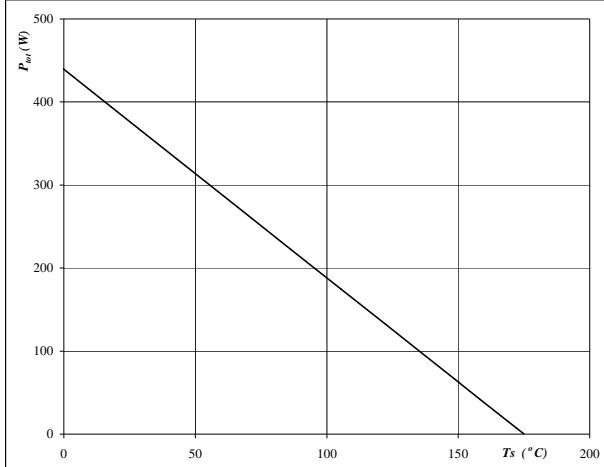
FWD thermal model values

R (K/W)	Tau (s)
4,35E-02	4,66E+00
7,48E-02	5,44E-01
1,95E-01	8,13E-02
2,13E-01	2,26E-02
4,51E-02	5,48E-03
4,51E-02	5,92E-04

Output Inverter

figure 21.
IGBT
**Power dissipation as a
function of heatsink temperature**

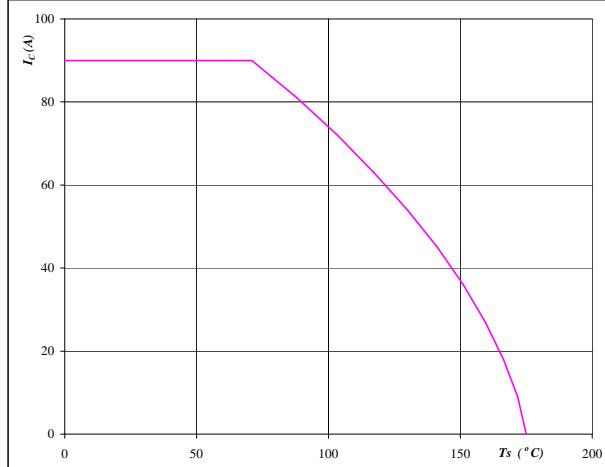
$$P_{\text{tot}} = f(T_s)$$


At

$$T_j = 175 \quad {}^\circ\text{C}$$

figure 22.
IGBT
**Collector current as a
function of heatsink temperature**

$$I_C = f(T_s)$$

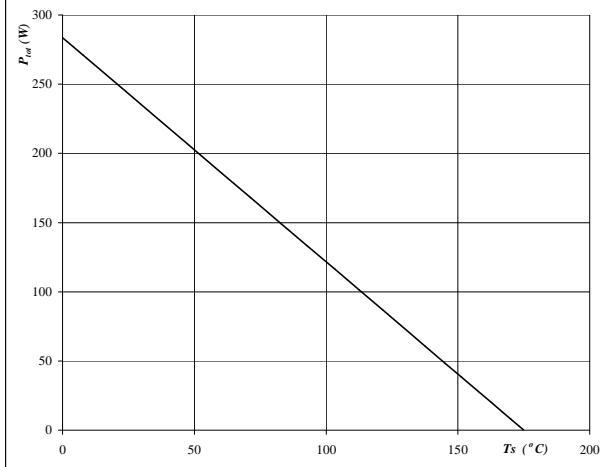

At

$$T_j = 175 \quad {}^\circ\text{C}$$

$$V_{\text{GE}} = 15 \quad \text{V}$$

figure 23.
FWD
**Power dissipation as a
function of heatsink temperature**

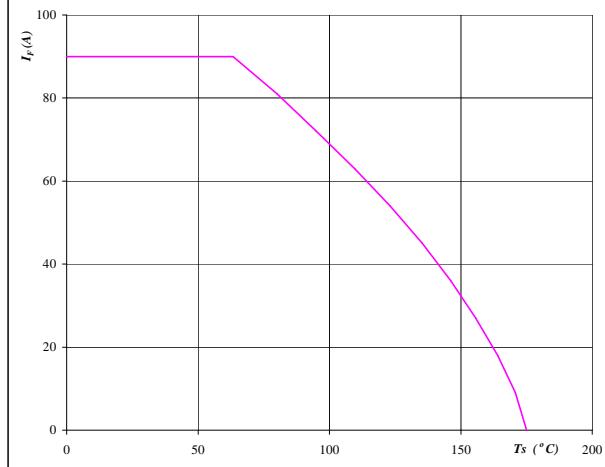
$$P_{\text{tot}} = f(T_s)$$


At

$$T_j = 175 \quad {}^\circ\text{C}$$

figure 24.
FWD
**Forward current as a
function of heatsink temperature**

$$I_F = f(T_s)$$

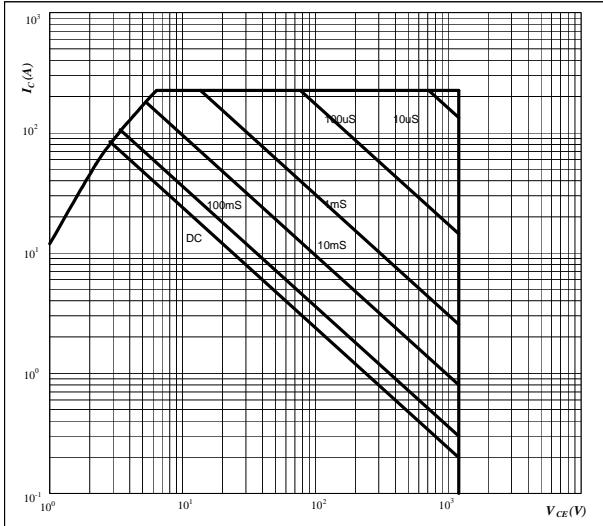

At

$$T_j = 175 \quad {}^\circ\text{C}$$

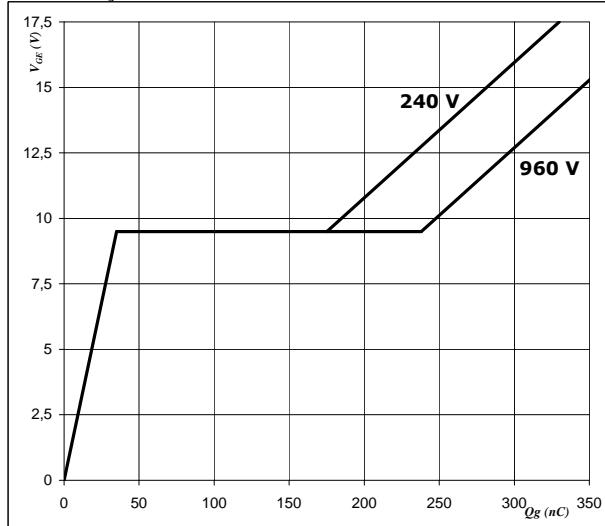
Output Inverter

figure 25.
IGBT
**Safe operating area as a function
of collector-emitter voltage**

$$I_C = f(V_{CE})$$


At
 $D = \text{single pulse}$
 $T_s = 80 \text{ } ^\circ\text{C}$
 $V_{GE} = \pm 15 \text{ V}$
 $T_j = T_{jmax}$
figure 26.
IGBT
Gate voltage vs Gate charge

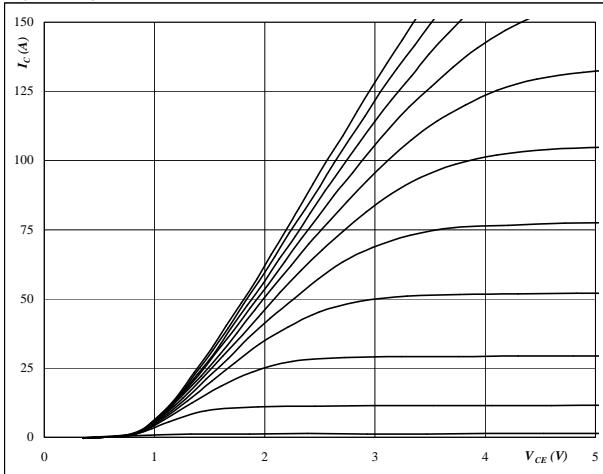
$$V_{GE} = f(Q_g)$$


At
 $I_C = 75 \text{ A}$

Brake

figure 1.
Typical output characteristics

$$I_C = f(V_{CE})$$


At

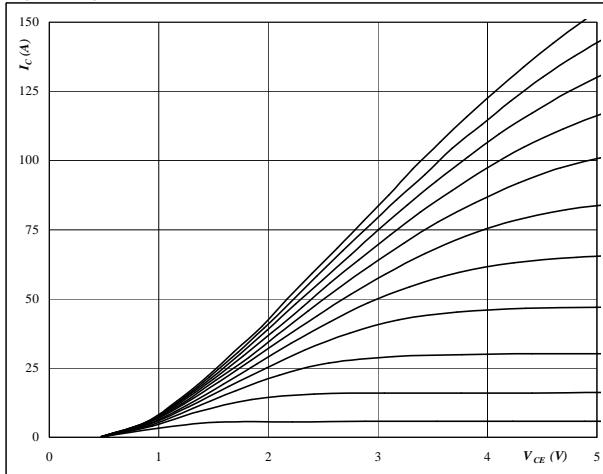
$$t_p = 250 \mu\text{s}$$

$$T_j = 25^\circ\text{C}$$

VGE from 7 V to 17 V in steps of 1 V

IGBT
figure 2.
Typical output characteristics

$$I_C = f(V_{CE})$$


At

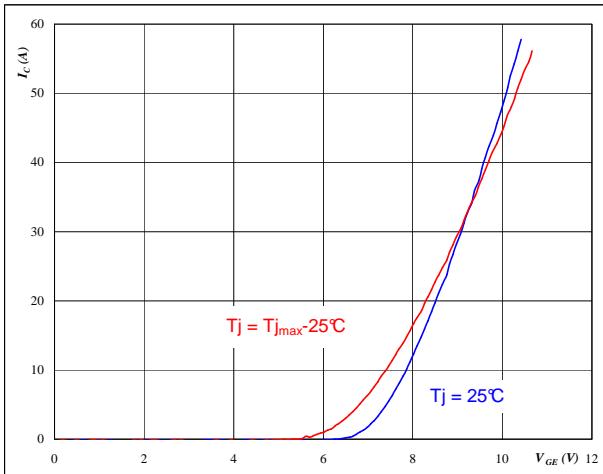
$$t_p = 250 \mu\text{s}$$

$$T_j = 150^\circ\text{C}$$

VGE from 7 V to 17 V in steps of 1 V

IGBT
figure 3.
IGBT
Typical transfer characteristics

$$I_C = f(V_{GE})$$

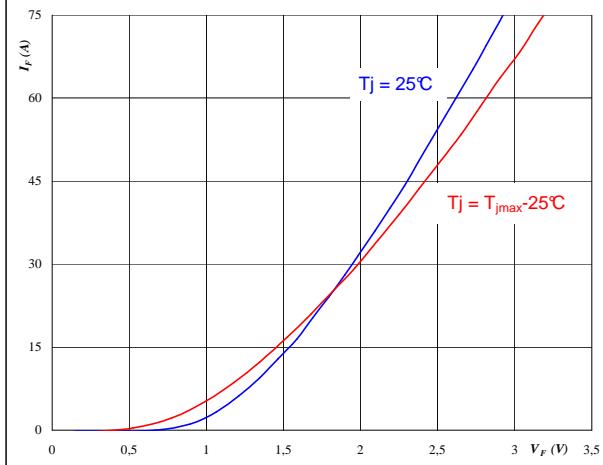

At

$$t_p = 250 \mu\text{s}$$

$$V_{CE} = 10 \text{ V}$$

figure 4.
FWD
Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$

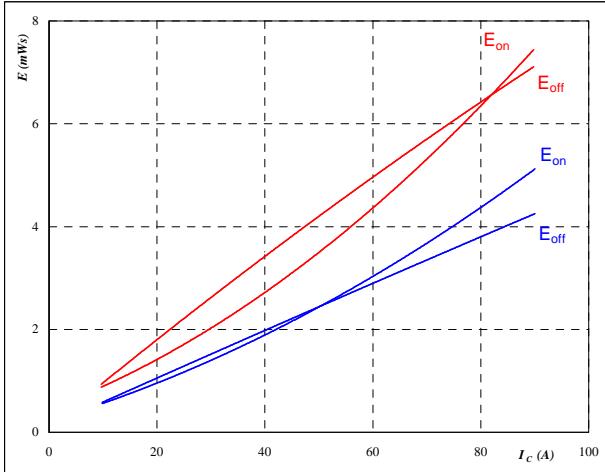

At

$$t_p = 250 \mu\text{s}$$

Brake

figure 5.
IGBT
**Typical switching energy losses
as a function of collector current**

$$E = f(I_C)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

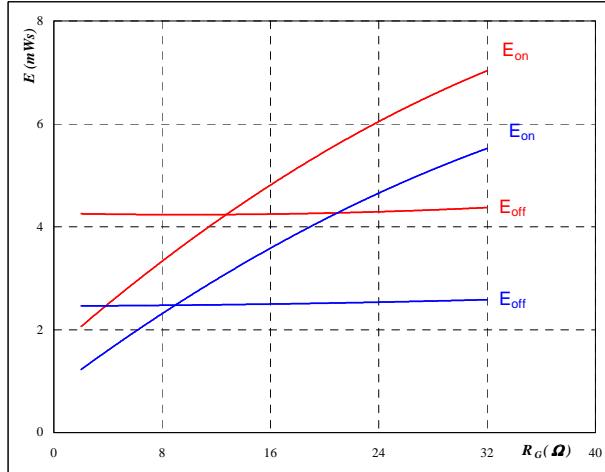
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 8 \quad \Omega$$

$$R_{goff} = 8 \quad \Omega$$

figure 6.
IGBT
**Typical switching energy losses
as a function of gate resistor**

$$E = f(R_G)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

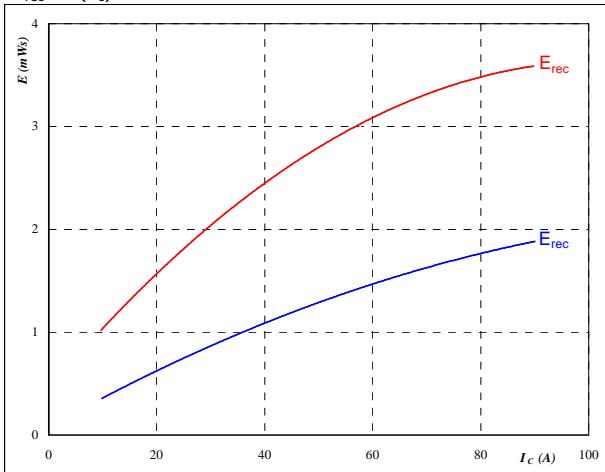
$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_C = 50 \quad \text{A}$$

figure 7.
IGBT
**Typical reverse recovery energy loss
as a function of collector current**

$$E_{rec} = f(I_C)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

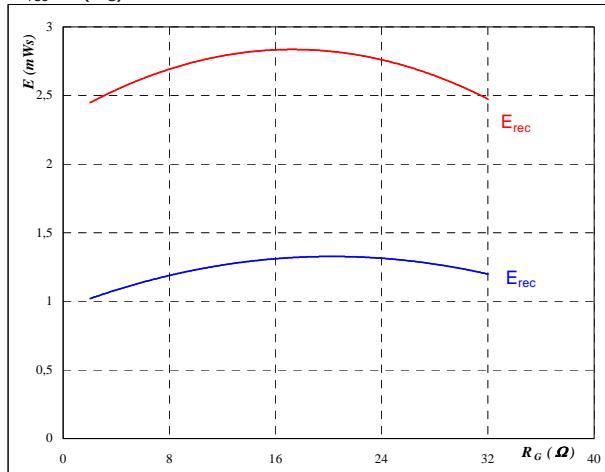
$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 8 \quad \Omega$$

figure 8.
IGBT
**Typical reverse recovery energy loss
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_C = 50 \quad \text{A}$$

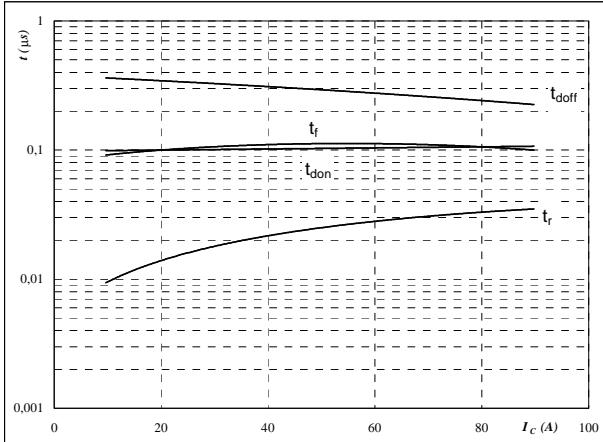
Brake

figure 9.

Typical switching times as a function of collector current

$$t = f(I_C)$$

IGBT



With an inductive load at

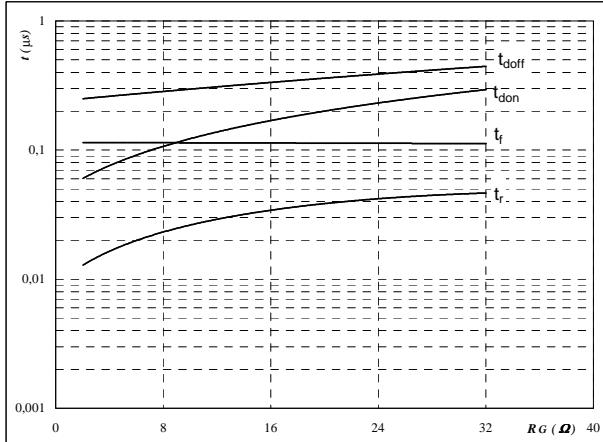
$$\begin{aligned} T_j &= 150 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 8 \quad \Omega \\ R_{goff} &= 8 \quad \Omega \end{aligned}$$

figure 10.

Typical switching times as a function of gate resistor

$$t = f(R_G)$$

IGBT



With an inductive load at

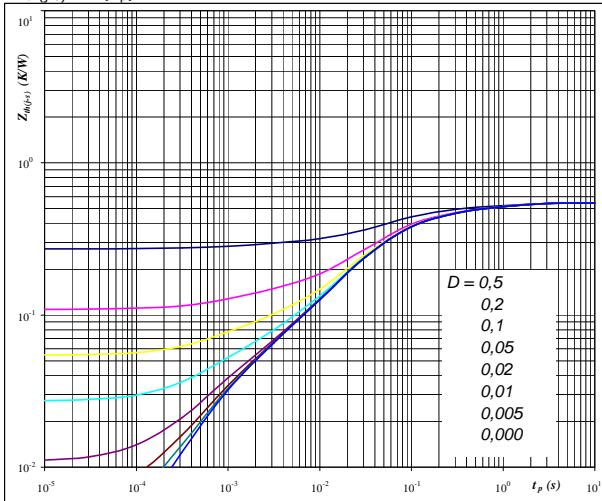
$$\begin{aligned} T_j &= 150 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_C &= 50 \quad \text{A} \end{aligned}$$

figure 11.

IGBT

IGBT transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



At

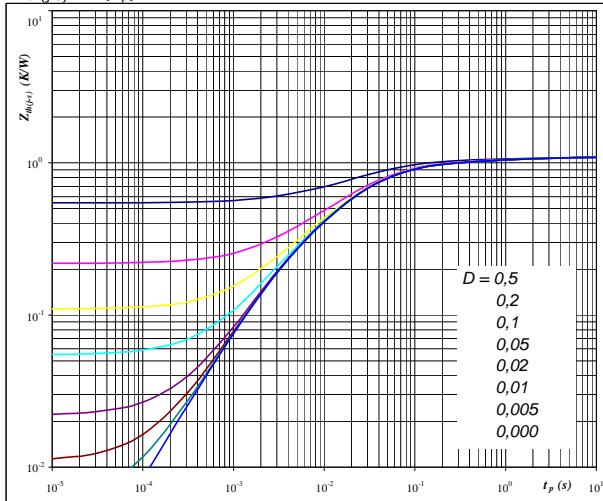
$$\begin{aligned} D &= t_p / T \\ R_{th(j-s)} &= 0.54 \quad \text{K/W} \end{aligned}$$

figure 12.

IGBT

FWD transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



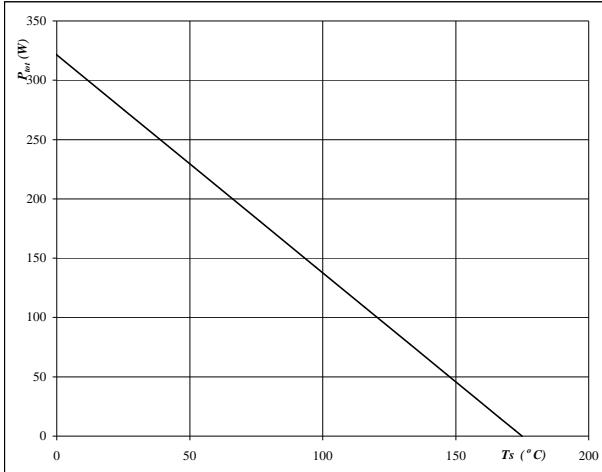
At

$$\begin{aligned} D &= t_p / T \\ R_{th(j-s)} &= 1.09 \quad \text{K/W} \end{aligned}$$

Brake

figure 13.
IGBT
**Power dissipation as a
function of heatsink temperature**

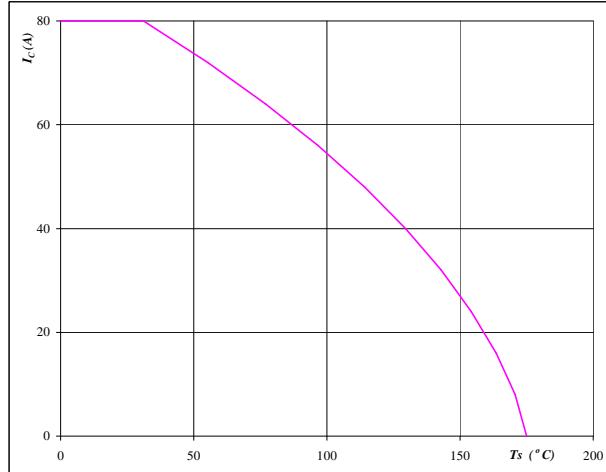
$$P_{\text{tot}} = f(T_s)$$


At

$$T_j = 175 \text{ } ^\circ\text{C}$$

figure 14.
IGBT
**Collector current as a
function of heatsink temperature**

$$I_C = f(T_s)$$

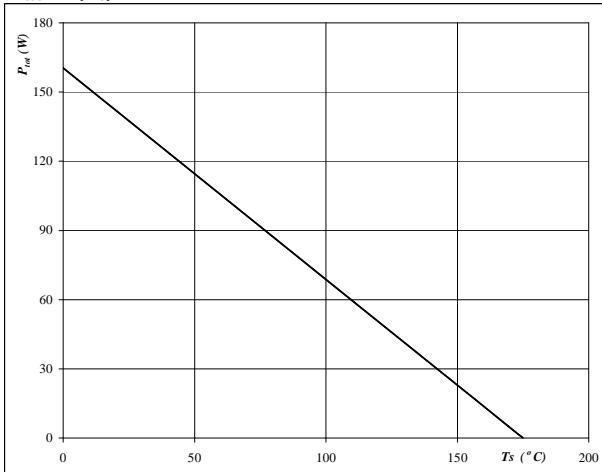

At

$$T_j = 175 \text{ } ^\circ\text{C}$$

$$V_{GE} = 15 \text{ V}$$

figure 15.
FWD
**Power dissipation as a
function of heatsink temperature**

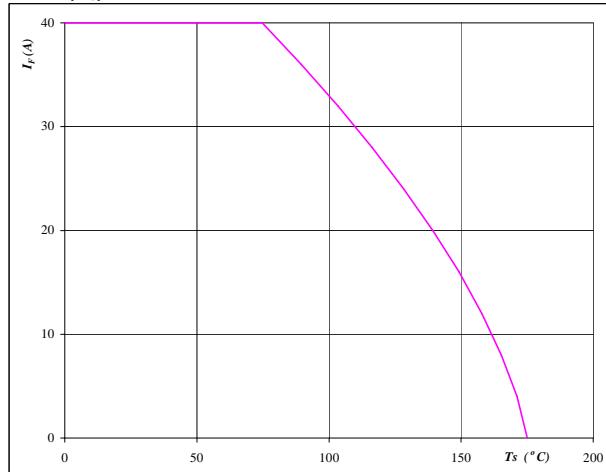
$$P_{\text{tot}} = f(T_s)$$


At

$$T_j = 175 \text{ } ^\circ\text{C}$$

figure 16.
FWD
**Forward current as a
function of heatsink temperature**

$$I_F = f(T_s)$$


At

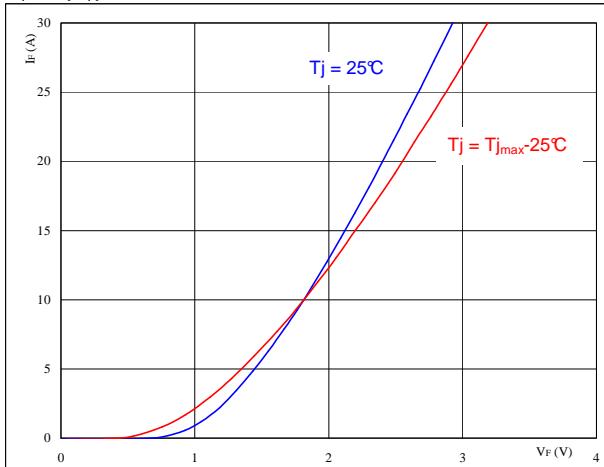
$$T_j = 175 \text{ } ^\circ\text{C}$$

Brake Inverse Diode

figure 1.**Brake inverse diode**

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$

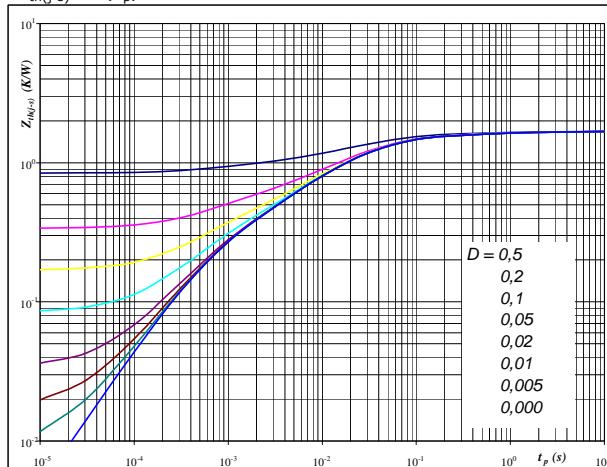
**At**

$$t_p = 250 \mu\text{s}$$

figure 2.**Brake inverse diode**

Diode transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

**At**

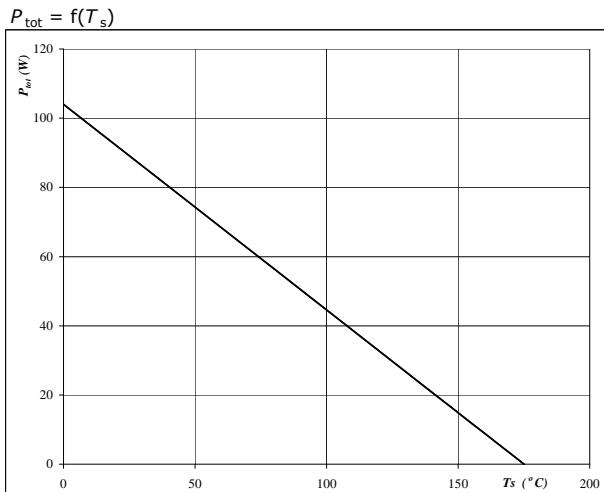
$$D = t_p / T$$

$$R_{th(j-s)} = 1,68 \text{ K/W}$$

figure 3.**Brake inverse diode**

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_s)$$

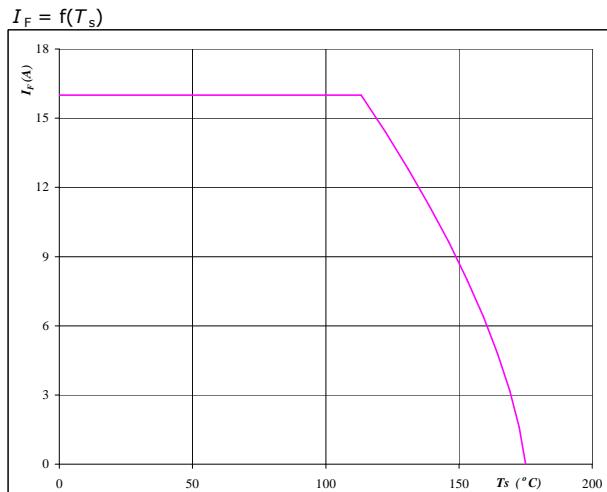
**At**

$$T_j = 175 \text{ °C}$$

figure 4.**Brake inverse diode**

Forward current as a function of heatsink temperature

$$I_F = f(T_s)$$

**At**

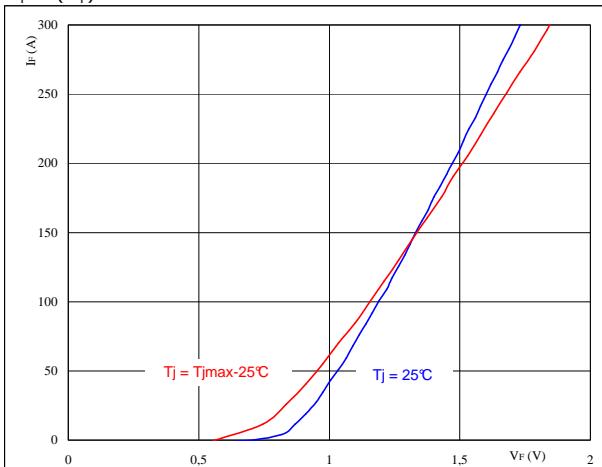
$$T_j = 175 \text{ °C}$$

Input Rectifier Bridge

figure 1.**Rectifier Diode**

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$

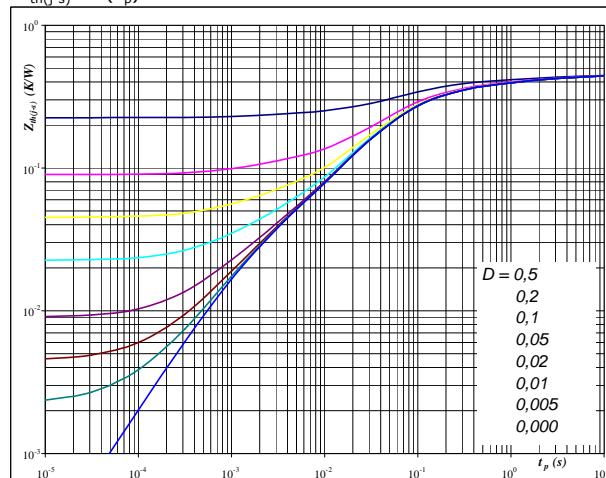
**At**

$$t_p = 250 \mu\text{s}$$

figure 2.**Rectifier Diode**

Diode transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

**At**

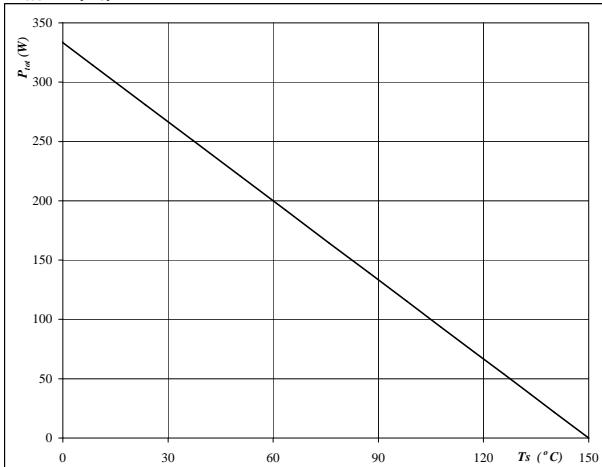
$$D = t_p / T$$

$$R_{th(j-s)} = 0,45 \text{ K/W}$$

figure 3.**Rectifier Diode**

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_s)$$

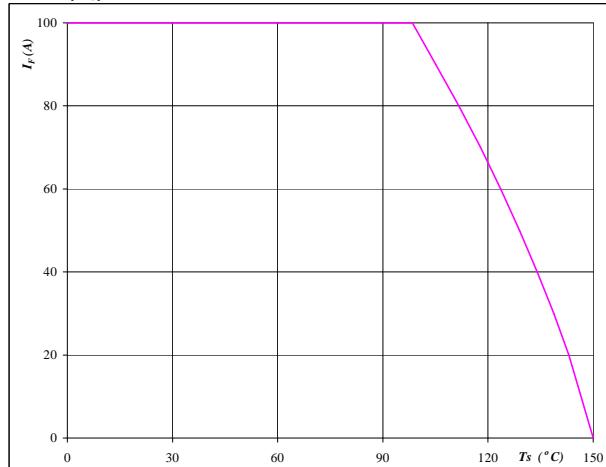
**At**

$$T_j = 150 ^\circ\text{C}$$

figure 4.**Rectifier Diode**

Forward current as a function of heatsink temperature

$$I_F = f(T_s)$$

**At**

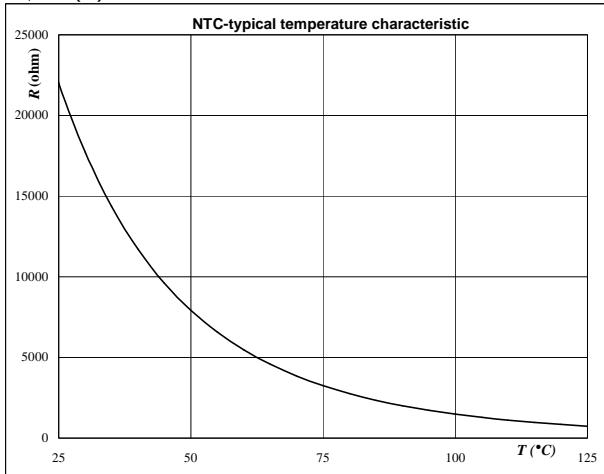
$$T_j = 150 ^\circ\text{C}$$

Thermistor

figure 1. Thermistor

**Typical NTC characteristic
as a function of temperature**

$$R_T = f(T)$$



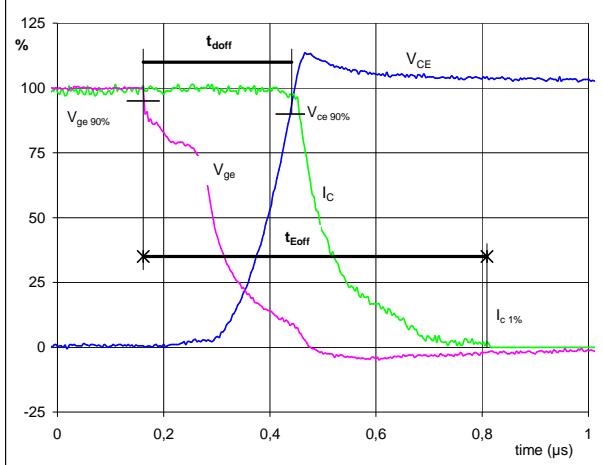
Switching Definitions Output Inverter

General conditions

T_j	= 150 °C
R_{gon}	= 8 Ω
R_{goff}	= 8 Ω

figure 1.

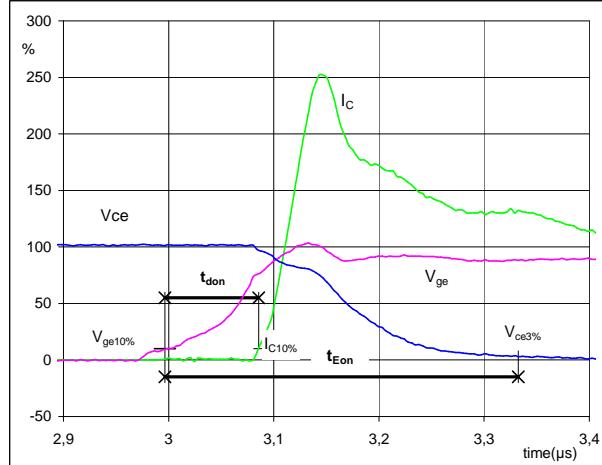
IGBT
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff}
 $(t_{Eoff} = \text{integrating time for } E_{off})$



$V_{GE}(0\%) = -15$ V
 $V_{GE}(100\%) = 15$ V
 $V_C(100\%) = 600$ V
 $I_C(100\%) = 75$ A
 $t_{doff} = 0,27$ μs
 $t_{Eoff} = 0,65$ μs

figure 2.

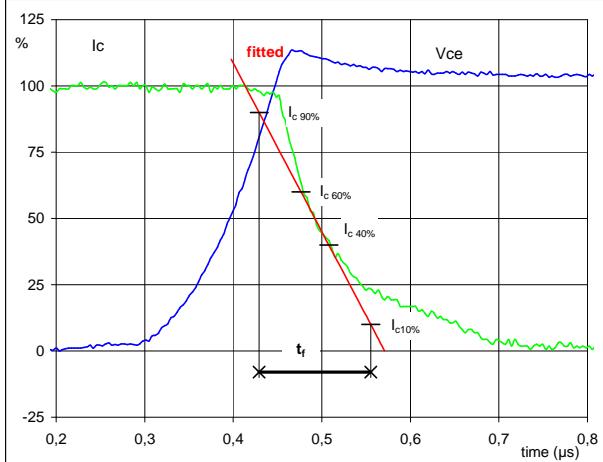
IGBT
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon}
 $(t_{Eon} = \text{integrating time for } E_{on})$



$V_{GE}(0\%) = -15$ V
 $V_{GE}(100\%) = 15$ V
 $V_C(100\%) = 600$ V
 $I_C(100\%) = 75$ A
 $t_{don} = 0,09$ μs
 $t_{Eon} = 0,34$ μs

figure 3.

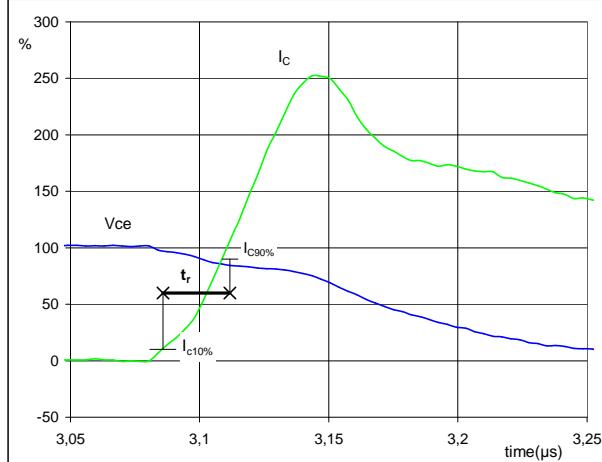
IGBT
Turn-off Switching Waveforms & definition of t_f



$V_C(100\%) = 600$ V
 $I_C(100\%) = 75$ A
 $t_f = 0,11$ μs

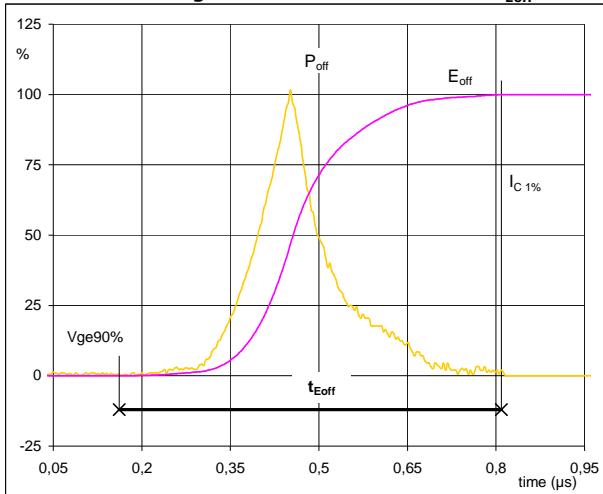
figure 4.

IGBT
Turn-on Switching Waveforms & definition of t_r

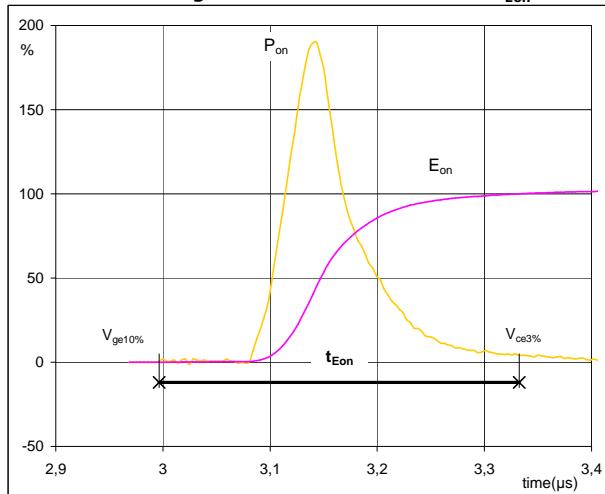


$V_C(100\%) = 600$ V
 $I_C(100\%) = 75$ A
 $t_r = 0,02$ μs

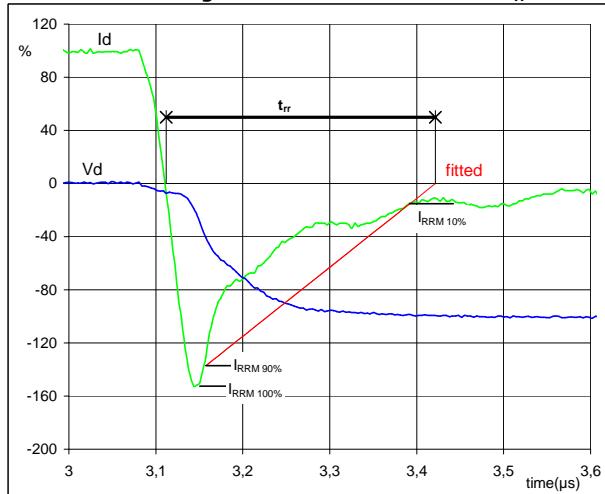
Switching Definitions Output Inverter

figure 5.**IGBT****Turn-off Switching Waveforms & definition of t_{Eoff}** 

$$\begin{aligned} P_{off} (100\%) &= 45,16 \text{ kW} \\ E_{off} (100\%) &= 6,39 \text{ mJ} \\ t_{Eoff} &= 0,65 \mu\text{s} \end{aligned}$$

figure 6.**IGBT****Turn-on Switching Waveforms & definition of t_{Eon}** 

$$\begin{aligned} P_{on} (100\%) &= 45,16 \text{ kW} \\ E_{on} (100\%) &= 6,39 \text{ mJ} \\ t_{Eon} &= 0,34 \mu\text{s} \end{aligned}$$

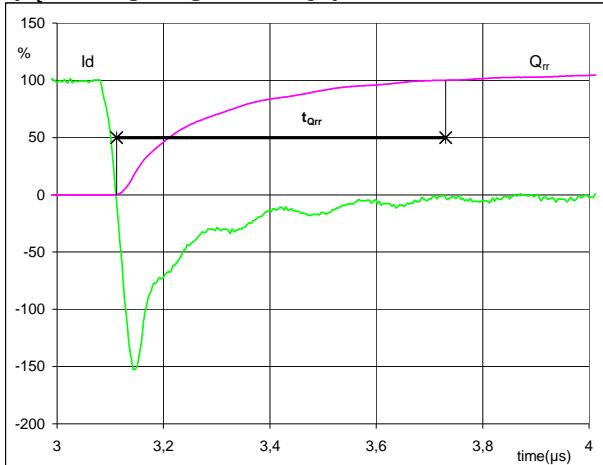
figure 7.**FWD****Turn-off Switching Waveforms & definition of t_{rr}** 

$$\begin{aligned} V_d (100\%) &= 600 \text{ V} \\ I_d (100\%) &= 75 \text{ A} \\ I_{RRM} (100\%) &= -117 \text{ A} \\ t_{rr} &= 0,31 \mu\text{s} \end{aligned}$$

Switching Definitions Output Inverter

figure 8.**FWD**

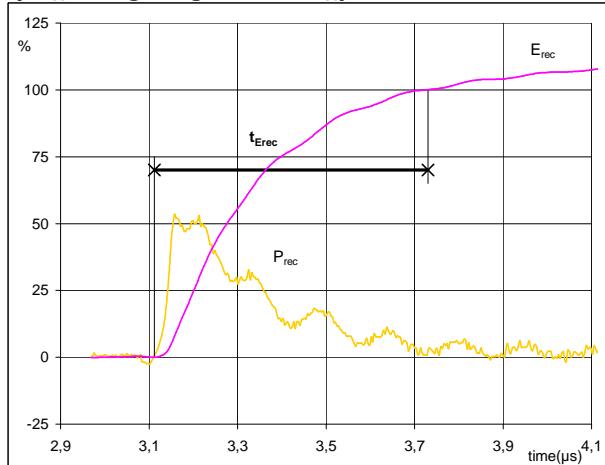
Turn-on Switching Waveforms & definition of t_{Qrr}
 $(t_{Qrr} = \text{integrating time for } Q_{rr})$



$I_d (100\%) = 75 \text{ A}$
 $Q_{rr} (100\%) = 14,13 \mu\text{C}$
 $t_{Qint} = 0,62 \mu\text{s}$

figure 9.**FWD**

Turn-on Switching Waveforms & definition of t_{Erec}
 $(t_{Erec} = \text{integrating time for } E_{rec})$

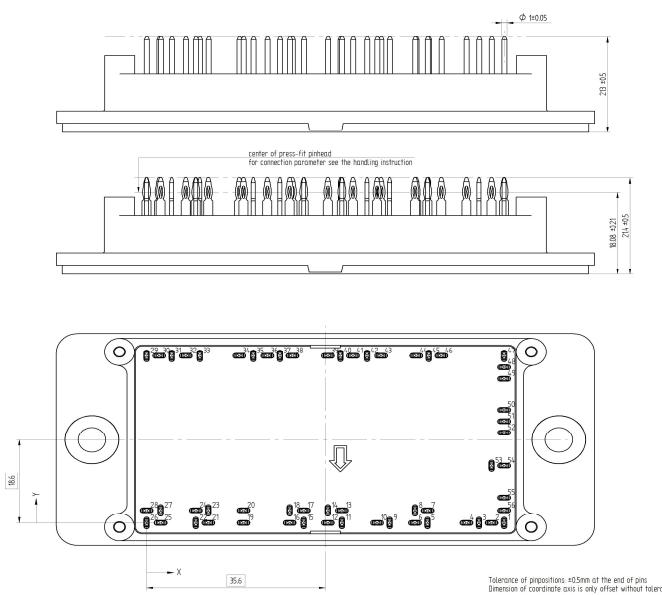


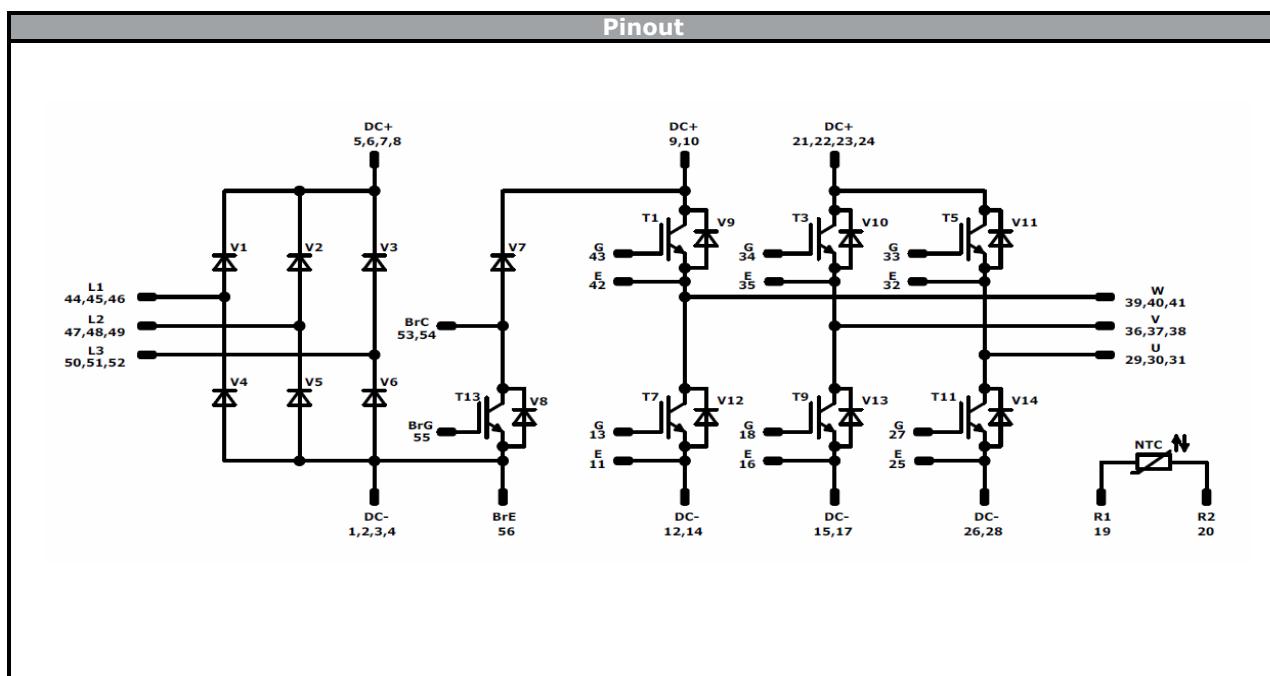
$P_{rec} (100\%) = 45,16 \text{ kW}$
 $E_{rec} (100\%) = 5,64 \text{ mJ}$
 $t_{Erec} = 0,62 \mu\text{s}$

Ordering Code and Marking - Outline - Pinout

Ordering Code & Marking							
Version		Ordering Code		in DataMatrix as		in packaging barcode as	
without thermal paste with Solder pins		V23990-P769-A-PM		P769A		P769A	
without thermal paste with Press-fit pins		V23990-P769-AY-PM		P769AY		P769AY	
with thermal paste with Solder pins		V23990-P769-A-/3/-PM		P769A		P769A-/3/	
with thermal paste with Press-fit pins		V23990-P769-AY-/3/-PM		P769AY		P769AY-/3/	

Outline							
Pin table [mm]				Pin table [mm]			
Pin	Func	X	Y	Pin	Func	X	Y
1	DC-	71,2	0	29	U	0	37,2
2	DC-	68,7	0	30	U	2,5	37,2
3	DC-	66,2	0	31	U	5	37,2
4	DC-	63,7	0	32	E	7,8	37,2
5	DC+	55,95	0	33	G	10,6	37,2
6	DC+	53,45	0	34	G	18,45	37,2
7	DC+	55,95	2,8	35	E	21,25	37,2
8	DC+	53,45	2,8	36	V	24,05	37,2
9	DC+	48,4	0	37	V	26,55	37,2
10	DC+	45,9	0	38	V	29,05	37,2
11	E	38,9	0	39	W	36,1	37,2
12	DC-	36,1	0	40	W	38,6	37,2
13	G	38,9	2,8	41	W	41,1	37,2
14	DC-	36,1	2,8	42	E	43,9	37,2
15	DC-	31,3	0	43	G	46,7	37,2
16	E	28,5	0	44	L1	53,7	37,2
17	DC-	31,3	2,8	45	L1	56,2	37,2
18	G	28,5	2,8	46	L1	58,7	37,2
19	R2	19,3	0	47	L2	71,2	37,2
20	R1	19,3	2,8	48	L2	71,2	34,7
21	DC+	12,3	0	49	L2	71,2	32,2
22	DC+	9,8	0	50	L3	71,2	25,2
23	DC+	12,3	2,8	51	L3	71,2	22,7
24	DC+	9,8	2,8	52	L3	71,2	20,2
25	E	2,8	0	53	BrC	71,2	12,8
26	DC-	0	0	54	BrC	68,7	12,8
27	G	2,8	2,8	55	BrG	71,2	5,6
28	DC-	0	2,8	56	BrE	71,2	2,8





Identification

ID	Component	Voltage	Current	Function	Comment
T1,T3,T5,T7,T9,T11	IGBT	1200V	70A	Inverter Switch	
V9-V14	FWD	1200V	75A	Inverter Diode	
T13	IGBT	1200V	50A	Brake Switch	
V7	FWD	1200V	25A	Brake Diode	
V8	FWD	1200V	10A	Brake Inverse Diode	
V1-V6	Rectifier	1600V	75A	Rectifier Diode	
NTC	NTC			Thermistor	



Vincotech

V23990-P769-A-PM**V23990-P769-AY-PM**

datasheet

Packaging instruction		>SPQ	Standard	<SPQ	Sample
Standard packaging quantity (SPQ)	36				

Handling instruction
Handling instructions for <i>flow</i> 2 packages see vincotech.com website.

Package data
Package data for <i>flow</i> 2 packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
V23990-P769-Ax-D9-14	31 Jan. 2019	flow2 frame modification	1, 22

DISCLAIMER

The information, specifications, procedures, methods and recommendations herein (together "information") are presented by Vincotech to reader in good faith, are believed to be accurate and reliable, but may well be incomplete and/or not applicable to all conditions or situations that may exist or occur. Vincotech reserves the right to make any changes without further notice to any products to improve reliability, function or design. No representation, guarantee or warranty is made to reader as to the accuracy, reliability or completeness of said information or that the application or use of any of the same will avoid hazards, accidents, losses, damages or injury of any kind to persons or property or that the same will not infringe third parties rights or give desired results. It is reader's sole responsibility to test and determine the suitability of the information and the product for reader's intended use.

LIFE SUPPORT POLICY

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.